



**EMV® Specification Bulletin No. 253**  
**April 2021**

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***Errata for EMV Book C-2 (Version 2.9)***

***This Specification Bulletin contains corrections for Book C-2 V2.9.***

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***Applicability***

This Specification Bulletin applies to:

- *EMV Contactless Specifications for Payment Systems, Book C-2, Kernel 2 Specification, Version 2.9, March 2020*

***Effective Date***

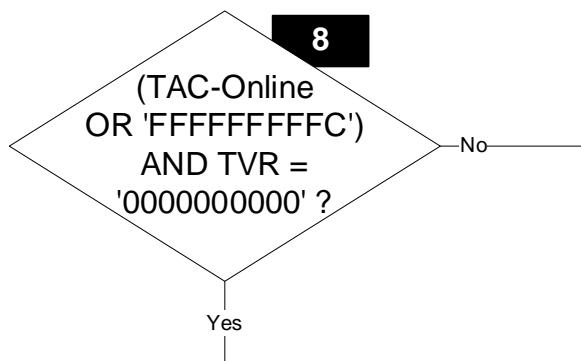
- 1 June 2021
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***Description***

This Specification Bulletin corrects errors in Book C-2 v2.9.

***Erratum 1***

Change TAA.8 as follows:



**TAA.8**

IF       $[(Terminal\ Action\ Code - Online \text{ OR } 'FFFFFFFC') \text{ AND Terminal\ Verification\ Results} = '0000000000']$

THEN

    GOTO TAA.9

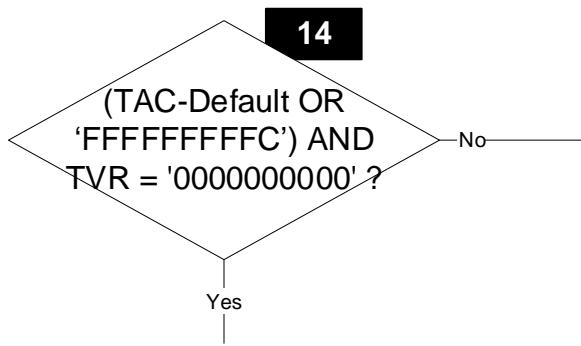
ELSE

    GOTO TAA.11

ENDIF

**Erratum 2**

Change TAA.14 as follows:



**TAA.14**

IF       $[(Terminal\ Action\ Code - Default \text{ OR } 'FFFFFFFC') \text{ AND } Terminal\ Verification\ Results = '0000000000']$   
THEN  
    GOTO TAA.15  
ELSE  
    GOTO TAA.17  
ENDIF

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